

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	42241	(electroplated electroplating electroplate electro (under adj3 bump) underbump) with (ni nickel gold au copper cu)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 18:03
L2	211030	((nickel ni) with (vanadium v)) ((copper cu) with (chromium cr))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 18:06
L3	6709	1 and 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 18:06
L4	7019779	aluminum al titanium ti tantalum ta chromium ((titanium ti) with (w tungsten)) ((ta tantalum) with (nitride n))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 18:09
L5	6405	(aluminum al titanium ti tantalum ta chromium ((titanium ti) with (w tungsten)) ((ta tantalum) with (nitride n))) and 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 18:10
L6	4662	(bond bonding pad terminal electrode) and 5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 18:10
L7	1362	(bump ball underbump (under adj4 (ball bump))) and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 18:11
L8	394	(trace redistribution redistribute redistributed redistributing) and 7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 18:50

L9	1323	(trace redistribution redistribute redistributed redistributing metallization metal) and 7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 18:13
L10	929	9 not 8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 18:50